

Appl. No. 10/773,088  
Amdt. Dated April 17, 2006  
Reply to Office Action of December 21, 2005

Attorney Docket No. 81784.0301  
Customer No. 26021



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:  
Mitsuru OKIGAWA  
Serial No.: 10/773,088  
Confirmation No.: 3288  
Filed: February 5, 2004  
For: SEMICONDUCTOR INTEGRATED  
DEVICE INCLUDING SUPPORT  
SUBSTRATE FASTENED USING  
RESIN, AND MANUFACTURING  
METHOD THEREOF

Art Unit: 2891

Examiner: Luan C. Thai

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Date

**AMENDMENT**

Mail Stop RCE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Dear Sir:

In conjunction with the Request for Continued Examination (RCE) being filed concurrently herewith, and in response to the Final Office Action of December 21, 2005, the period for response to which has been extended by the enclosed Petition to April 21, 2006, please amend the above-identified application as follows:

**Amendments** to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

**Remarks/Arguments** begin on page 4 of this paper.